MA27E02

Silicon epitaxial planar type

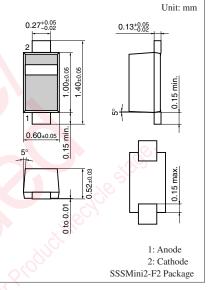
For cellular phone

Features

- High-frequency wave detection is possible.
- \bullet Low forward voltage $V_{\rm F}$
- \bullet Small terminal capacitance C_t

John Star						
Parameter	Symbol	Rating	Unit			
Reverse voltage	VR	20	V			
Maximum peak reverse voltage	V _{RM}	20	V			
Forward current	I _F	35	mA			
Peak forward current	I _{FM}	100	mA			
Junction temperature	Tj	125	°C			
Storage temperature	T _{stg}	-55 to +125	°C			

Absolute Maximum Ratings $T_a = 25^{\circ}C$



Marking Symbol: G

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V _{F1}	$I_F = 1 \text{ mA}$	0 ⁰	S	0.40	V
	V _{F2}	$I_F = 35 \text{ mA}$	in the	5	1.0	V
Reverse current	S ^C I _R	V _R = 15 V	$\mathcal{Q}^{\mathcal{O}}$		200	nA
Terminal capacitance	Ct	$V_R = 0 V, f = 1 MHz$			1.2	pF
Forward dynamic resistance	r _f	$I_F = 5 \text{ mA}$		9		Ω

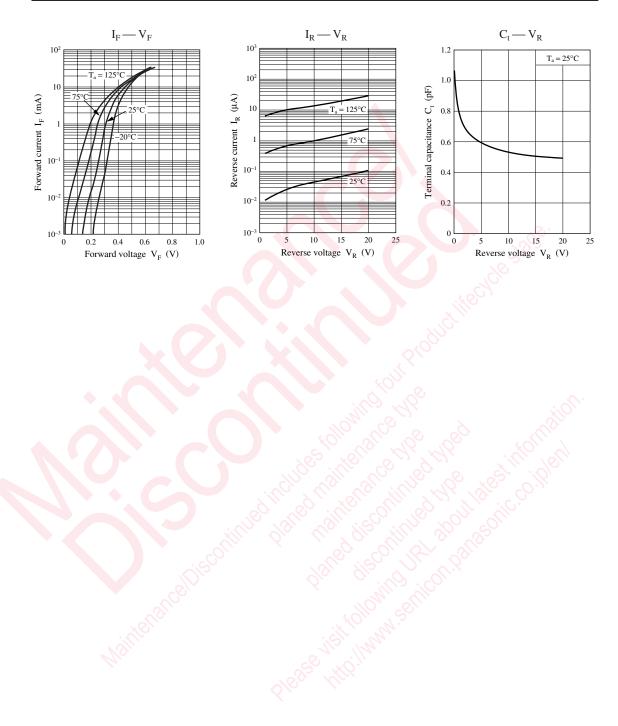
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

3. Rated input/output frequency: 2 GHz

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